Docket No.:

## **DECLARATION AND POWER OF ATTORNEY**

| As a below named inventor, I l  | nereby declare that:   |   |
|---|--|---|
| My residence, post office and c   | itizenship are as stated below next to my n  | ame,  |
| I believe I am the original, first<br>names are listed below) of the<br>SWITCHING METHOD USIN | subject matter claimed and for which a p   | ed below) or an original, first and joint inventor (if plural patent is sought on the invention entitled <u>VIAN DATA</u>   |
| [X] is attached hereto]] warended   | as filed onas Applicat   | ion Serial No and was f applicable)   |
| I hereby state that I have review<br>by any amendment referred to                             | ed and understand the contents of the above  | e identified specification, including the claims, as amended  |
| I acknowledge the duty to discl<br>Code of Federal Regulations, S                             | ose information which is known to me to ection 1.56(a).  | be material to patentability in accordance with Title 37,   |
| America, listed below and have  | I international application which designate<br>also identified below, by checking the box.   | <ul> <li>b) of any foreign application(s) for patent or inventor's<br/>d at least one country other than the United States of<br/>any foreign application for patent or inventor's certificate,<br/>the application on which priority is claimed.</li> </ul>  |
| Prior Foreign Application(s): Number  | Country  | Foreign Filing Date<br>Month/Day/Year   |
| 81159/2000  | Republic of Korea  | December 23, 2000   |
|   |  |   |
| I hereby claim the benefit unde   | r 35 U.S.C. 119(e) of any United States pro  | ovisional application(s) listed below.  |
| Application Number(s)   | Filing Date(Month/   | Day/Year)   |
|   |  |   |
| not disclosed in the prior United<br>112, I acknowledge the duty to                           | f America, listed below and, insofar as the<br>I States or PCT international application in<br>disclose information which is material to r | ation(s), or 365(c) of any PCT international application<br>subject matter of each of the claims of this application is<br>the manner provided by the first paragraph of 35 U.S.C.<br>attentability as defined in 37 CFR 1.56 which became<br>or PCT international filing date of this application. |
| Prior U. S. Application<br>or PCT Patent Number   | Filing Date(Month/Day/Year)  | Parent Patent Number(if application)  |
|   |  |   |
| like so made are punishable by f  | d further that these statements were made  | true and that all statements made on information and<br>with the knowledge that willful false statements and the<br>on 1001 of Title 18 of the United States Code and that<br>or any patent issued thereon.   |

I hereby appoint the following attorney(s) and/or spent(s).Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Bisenhart, Registration No. 38,128, and Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuurt I. Smith, Registration No. 42,159, all

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all further correspondence should be addressed to them Full name of solo or first inventor: Ju-Sup LEE Inventor's signature: Ju SUP Lee Date: DEC, 19,20 Mailing Address: Poonglim Hosu-maeul Apt. 112-1801, Choji-Dong, Ansan, Kyungki-Do, Korea Citizenship: Republic of Korea Residence Address (only if different from mailing address): · 实现在我们在外面的最后还要在这种的对方不是有的,我们就是我们的是我们的,我们就是我们的,我们的,我们就是我们的,我们就是我们的,我们就是我们的,我们就是我们的,我们 Full name of joint inventor(s): Jeong Hyun CHOI Jeong Hyun Chai. Inventor's signature: Date: DEC, 19, 2001 Mailing Address: Jukong Apt. 407-403, Haan 2-Dong, Kwangmyung, Kyungki-Do, Korea Citizenship: Residence Address (only if different from mailing address): · 新斯斯斯格特斯特外格特特特特斯格特特斯斯特斯斯斯斯斯特斯特斯特斯特特特斯特斯特斯特 Full name of joint inventor(s): Inventor's signature: Date: Mailing Address: Citizenship: Residence Address (only if different from mailing address):